

LOC	DIST	REVISIONS						
		P	LTR	DESCRIPTION	DATE	DWN	APVD	
GP	00		C	REVISED PER ECO-08-011351	19MAY2008	ZMR	JRP	
			D	REVISED PER ECO-10-021738	04JAN2011	CJV	JTL	
			D1	REVISED PER ECO-14-010419	11JUL2014	JW	SH	
			E	REVISED PER ECO-15-013594	22SEP2015	JW	SH	

1 MATERIAL: 0.25 THICK COPPER ALLOY.

2 FINISH:
CAGE: 1.25µm MIN TIN OVER NICKEL FLASH. NON
PLATED EDGES PERMISSIBLE.
SPRINGS: 0.8µm MIN TIN OVER 0.8µm MIN NICKEL
NON PLATED EDGES PERMISSIBLE.

3 PADS AND VIAS CHASSIS GROUND.

4 DATUM AND BASIC DIMENSIONS ESTABLISHED BY CUSTOMER.

5. MATES WITH SFP MSA COMPLIANT TRANSCEIVERS.

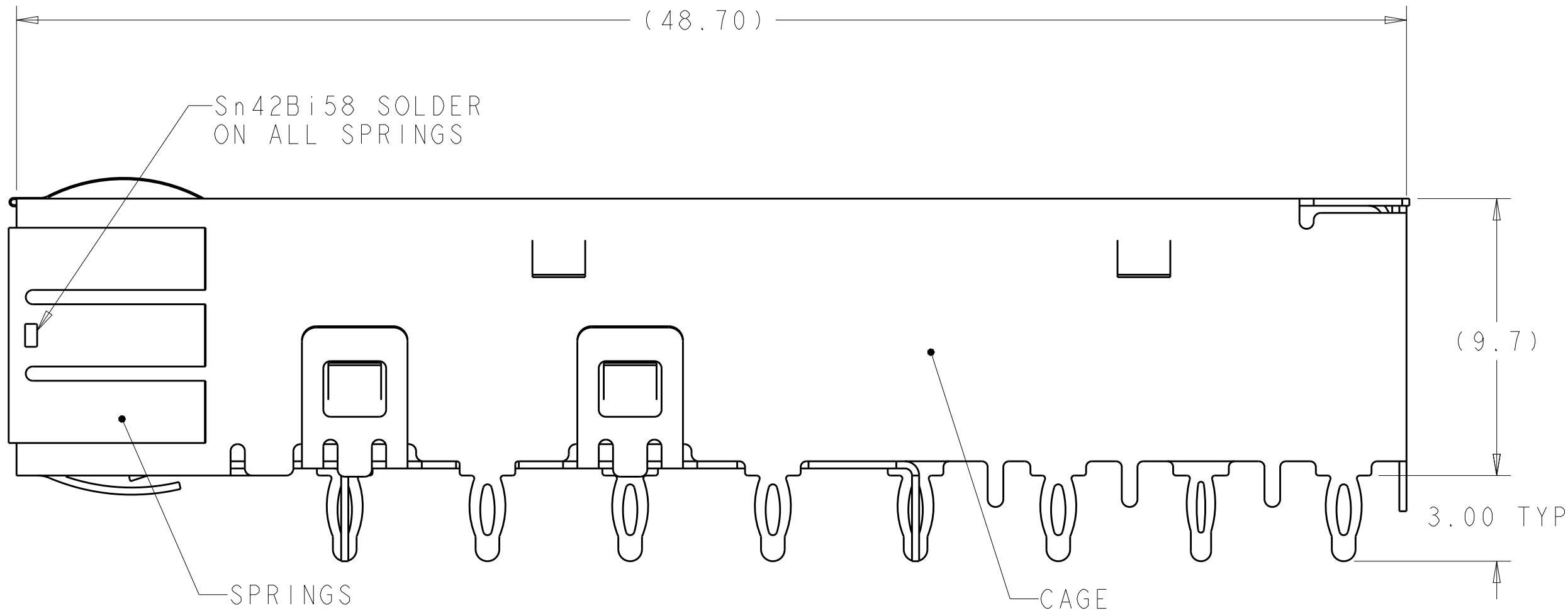
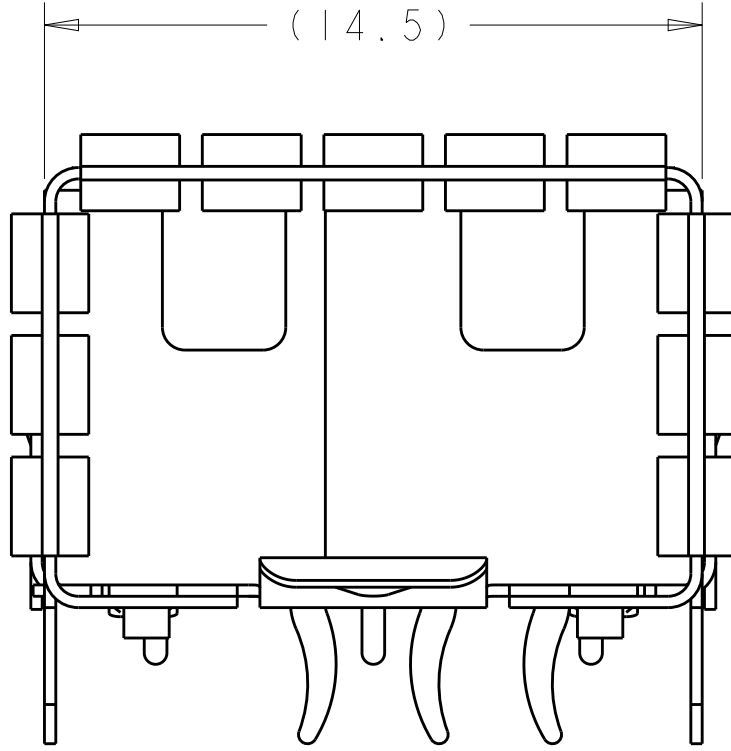
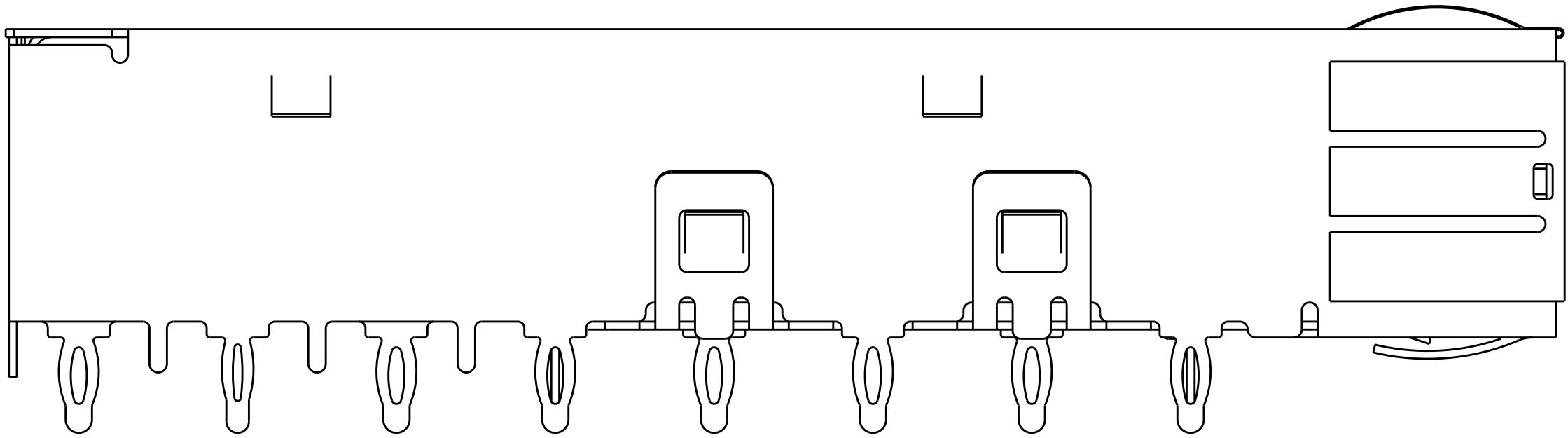
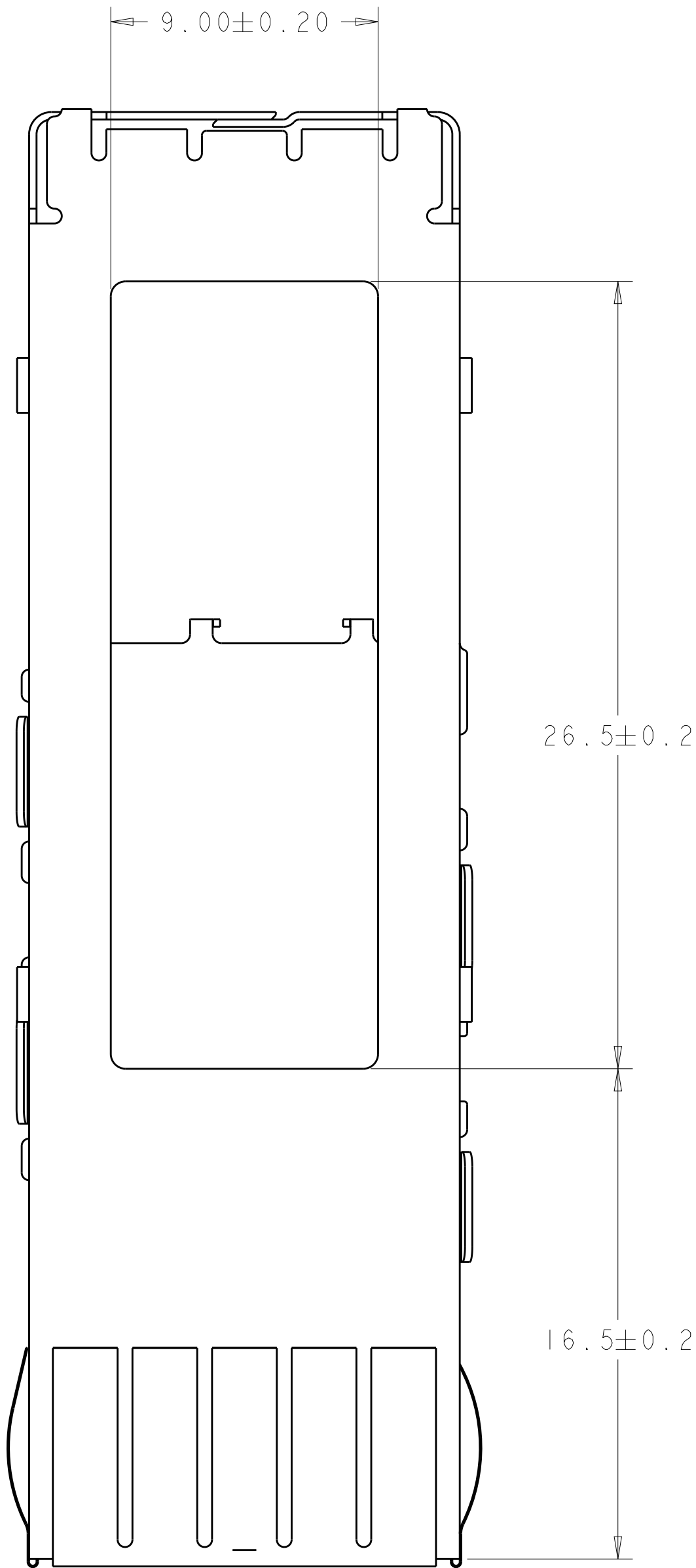
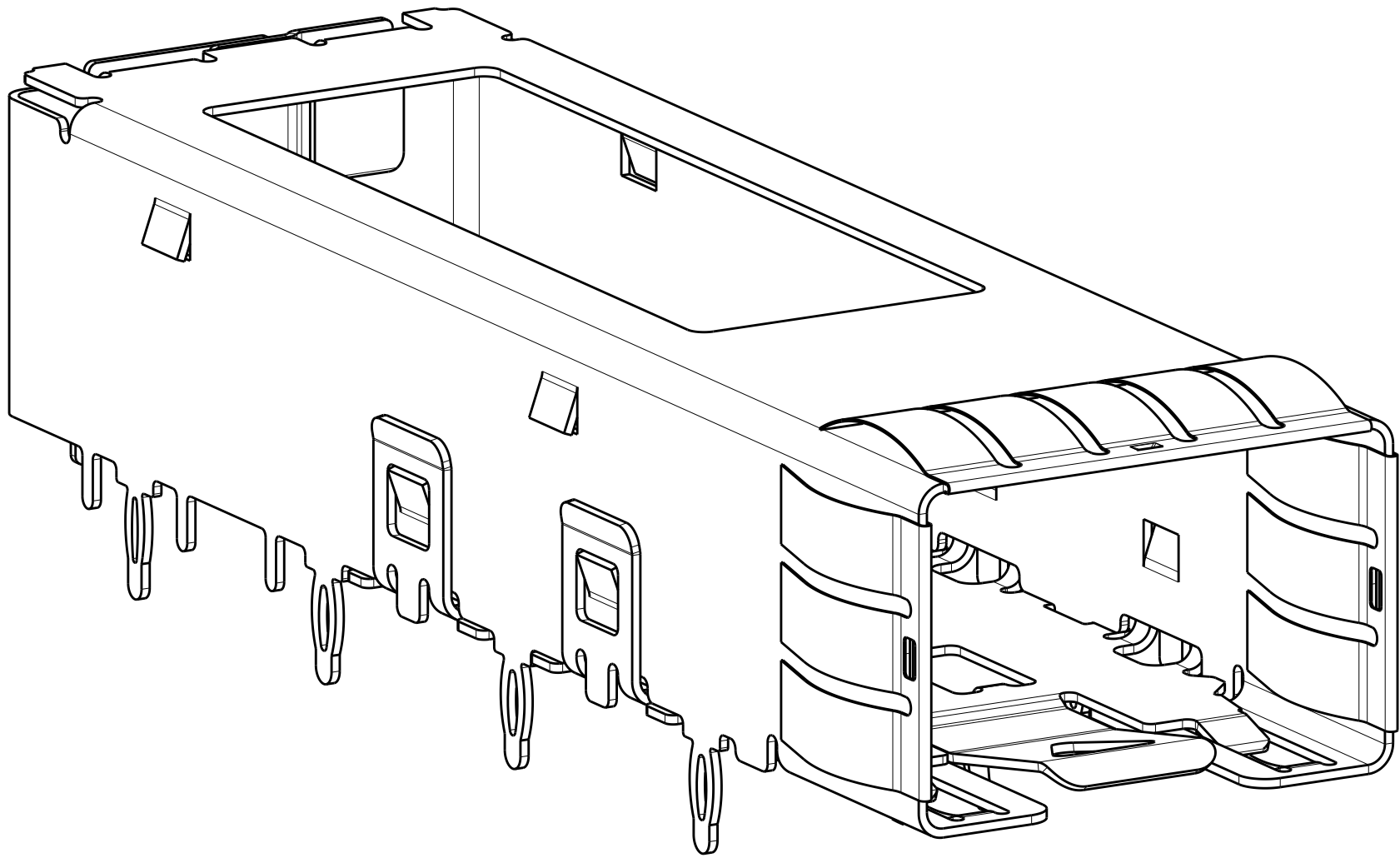
6 REFERENCE APPLICATION SPEC 114-13178, HOLE A, FOR RECOMMENDED
DRILL HOLE DIAMETER AND PLATING THICKNESSES.

7 REFERENCE APPLICATION SPEC 114-13178, HOLE C, FOR RECOMMENDED
DRILL HOLE DIAMETER AND PLATING THICKNESSES.

8. MINIMUM PC BOARD THICKNESS:
SINGLE SIDED = 1.45
DOUBLE SIDED = 3.00

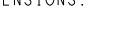
9 MATERIAL: NICKEL-SILVER ALLOY

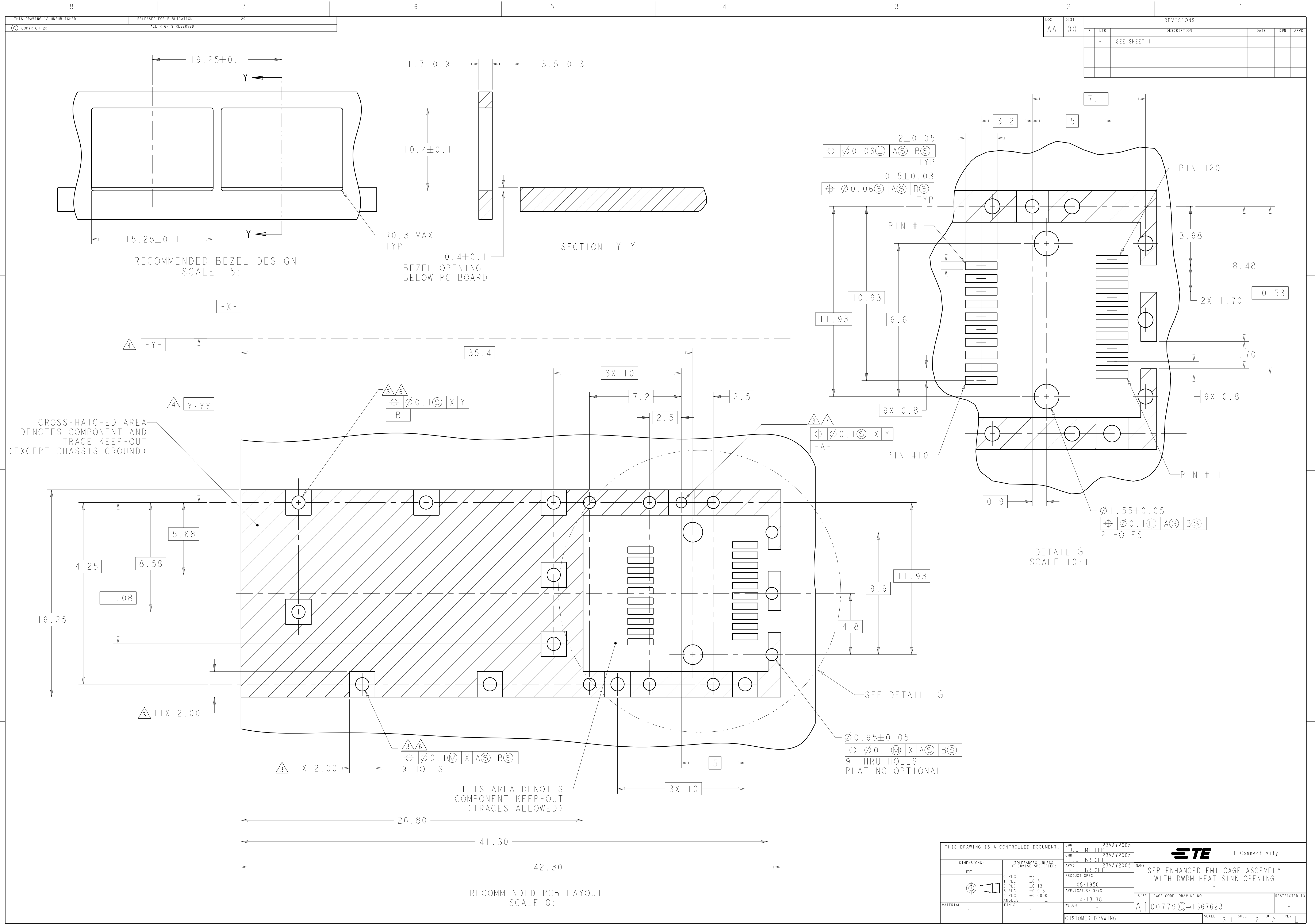
10 FINISH:
CAGE: NO PLATING
SPRING: 0.8µm MIN TIN OVER 0.8µm MIN NICKEL
NON PLATED EDGES PERMISSIBLE.



SUPERSEDED BY:
1367623-2

AS SHOWN	10	9	1367623-2
AS SHOWN	2	1	1367623-1
DESCRIPTION	FINISH	MATERIAL	PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN	J. MILLER	23MAY2005	 TE Connectivity	
DIMENSIONS:		CHK	E. J. BRIGHT	23MAY2005		
mm	TOLERANCES UNLESS OTHERWISE SPECIFIED:	APVD	F. J. BRIGHT	23MAY2005	NAME	SFP ENHANCED EMI CAGE ASSEMBLY WITH DWDM HEAT SINK OPENING
	0 P/LC ±.1 1 P/LC ±0.5 2 P/LC ±0.10 3 P/LC ±0.013 4 P/LC ±0.0001 ANGLES ±.1	PRODUCT SPEC 108-1950		SIZE CAGE CODE DRAWING NO RESTRICTED TO A100779C=1367623		
		APPLICATION SPEC				
		WEIGHT 11.4-13.178				
MATERIAL	FINISH	CUSTOMER DRAWING		SCALE 6:1 SHEET 1 OF 2 REV E		
 1	 2					



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Authorized Distributor

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[TE Connectivity:](#)

[1367623-1](#)